



Additional Information



Agency Recognitions

Agency	Agency File Number
91	E128662

Maximum Ratings and Thermal Characteristics $(T_{A}=25^{\circ}C \text{ unless otherwise noted})$

Parameter	Symbol	Value	Unit
Operating Storage Temperature Range	T _{stg}	-55 to 150	°C
Operating Junction Temperature Range	T	-55 to 125	°C
Current Rating ¹	I_{PP}	3	kA

Note:

1. Rated I_{PP} measured with 8/20µs pulse.

Description

The AK3-Y series of high power TVS diode is specially designed for meeting severe surge test environment of both AC and DC line protection applications. It features a very fast response and ultra low clamping characteristics as compared to MOVs (Metal Oxide Varistors). It accomplishes this by virtue of the Littelfuse FoldbakTM technology,which provides a clamping voltage lower than the avalanche voltage (but above the rated working voltage); therefore, any voltage rise due to increased current conduction is maintained at a minimum magnitude, providing the best possible protection level. These AK components can be connected in series and / or parallel to create a very high surge current protection solution.

Features & Benefits

- Recognized to UL 497B as an Isolated Loop Circuit Protector
- Both reflow and wave soldering capable
- Very low clamping voltage
- Ultra compact: less than onetenth the size of traditional discrete solutions
- Sharp breakdown voltage
- Low slope resistance
- Bi-directional
- FoldbakTM technology for superior clamping factor
- Symmetric in leads width for easier soldering during assembly.

- IEC 61000-4-2 ESD 15kV(Air), 8kV (Contact)
- ESD protection of data lines in accordance with IEC 61000-4-2
- EFT protection of data lines in accordance with IEC 61000-4-4
- Halogen-free and RoHS compliant
- Glass passivated junction
- Pb-free E4 means 2nd level interconnect is Pb-free and the terminal finish material is silver

Functional Diagram



Electrical Characteristics (T_A=25°C unless otherwise noted)

Part Numbers		Voltage	Max. Reverse Leakage	Typical I _R @ 85°C	Reverse Breakdown Voltage ($V_{\rm BR}$) @ $I_{\rm T}$		Test Current I _T	V _{cL} @ I _{pp}	oing Voltage Peak Pulse ٫٫) (Note 1)	Max. Temp Coefficient OF V _{BR}	Max. Capacitance 0 Bias 10kHz	Agency Approval
	J	Volts	(I _R) @V _{so} μΑ	(µA)	Min Volts	Max Volts	(mA)	$\mathbf{V}_{\rm CL}\mathbf{Volts}$	I _{PP} Amps	(%/°C)	(nF)	9 1
AK3-015C-Y	3-015C	15	10	15	16	19	10	28	3,000	0.1	12.0	Х
AK3-030C-Y	3-030C	30	10	15	32	37	10	90	3,000	0.1	11.0	Х
AK3-038C-Y	3-038C	38	10	15	40	46	10	95	3,000	0.1	10.0	-
AK3-058C-Y	3-058C	58	10	15	64	70	10	110	3,000	0.1	6.0	Х
AK3-066C-Y	3-066C	66	10	15	72	80	10	120	3,000	0.1	6.0	Х
AK3-076C-Y	3-076C	76	10	15	85	95	10	140	3,000	0.1	6.0	Х
AK3-150C-Y	3-150C	150	10	15	158	194	10	230	3,000	0.1	2.6	Х
AK3-170C-Y	3-170C	170	10	15	179	220	10	260	3,000	0.1	2.4	Х
AK3-190C-Y	3-190C	190	10	15	200	245	10	290	3,000	0.1	2.4	Х
AK3-208C-Y	3-208C	208	10	15	223	246	10	306	3,000	0.1	2.4	Х
AK3-380C-Y	3-380C	380	10	15	401	443	10	520	3,000	0.1	2.0	Х
AK3-430C-Y	3-430C	430	10	15	440	490	10	625	3,000	0.1	2.0	Х

Note: 1. Using 8/20µs wave shape as defined in IEC 61000-4-5.



Ratings and Characteristic Curves (T_A =25°C unless otherwise noted) (Continued)



Figure 3: Typical Peak Pulse Power Rating Curve



Figure 5: Surge Response (8/20 Surge current waveform)



Note: The power dissipation causes a change in avalanche voltage during the surge and the avalanche voltage eventually returns to the original value when the transient has passed.



Figure 2:

Pulse Waveform

Figure 4: Typical VBR Vs Junction Temperature



TVS Diodes Datasheet

Soldering Parameters

Reflow Cond	ition	Lead–free assembly	
	- Temperature Min (T _{s(min)})	150°C	
Pre Heat	- Temperature Max (T _{s(max)})	200°C	
	- Time (min to max) (t _s)	60 – 120 secs	
Average ram peak	p up rate (Liquidus Temp (T _A) to	3°C/second max	
T _{S(max)} to T _A - F	Ramp-up Rate	3°C/second max	
D (1	- Temperature (T _L) (Liquidus)	217°C	
Reflow	- Time (min to max) (t _L)	60 – 150 seconds	
Peak Tempera	ature (T _P)	260+0/-5 °C	
Time within !	5°C of actual peak Temperature (t _p)	30 seconds	
Ramp-down	Rate	6°C/second max	
Time 25°C to	peak Temperature (T _p)	8 minutes Max.	
Do not excee	d	260°C	



Flow Soldering (Solder Dipping)

Reflow Cond	ition	Lead–free assembly	
Pre Heat	- Temperature Min (T _{s(min)})	140°C	
	- Temperature Max (T _{s(max)})	160°C	
	- Time to Pre-Heat Temp	60 – 150 secs	
Average ram	p up rate to Pre-Heat Temp	5°C/second max	
Peak Tempera	ature (T _P)	260 ^{+0/-5} °C	
Average ram	p up rate (pre-heat to T _p)	5°C/second max	
Time within	actual peak Temperature Max	6 seconds	
Ramp-down	Rate	5°C/second max	

Physical Specifications

Weight	Contact manufacturer
Case	UL Recognized compound meeting flammability rating V-0
Terminal	Silver plated leads, solderable per MIL-STD-750 Method 2026





Dimensions





	Dimensions	Inches	Millimeters		
Α		0.951 +/- 0.040	24.15 +/- 1.00		
в		0.094 +/- 0.024	2.40 +/- 0.60		
с		0.236 +/- 0.039	6.00 +/- 1.00		
C	-208C	0.145 +/- 0.040	3.68 +/- 1.00		
D		0.433 max.	11.0 max.		
Е		0.050 +/- 0.002	1.27 +/- 0.05		
F		0.374 max.	9.50 max.		
	-015C	0.093 +/- 0.039	2.36 +/- 1.00		
	-030C/-038C/-066C	0.130 +/- 0.047	3.30 +/- 1.20		
	-058C/-076C	0.168 +/- 0.047	4.27 +/- 1.20		
G	-150C	0.383 +/- 0.047	9.72 +/- 1.20		
G	-170C/-190C	0.420 +/- 0.047	10.67 +/- 1.20		
	-208C	0.358 +/- 0.047	9.10 +/- 1.20		
	-380C	0.547 +/- 0.047	13.90 +/- 1.20		
	-430C	0.583 +/- 0.047	14.80 +/- 1.20		
	-208C	0.296 +/- 0.047	7.52 +/- 1.20		
L1		L1= L2 tolerance +/- 0. mm)	.047 inch (+/- 1.20		
12		= A - (G+L1) tolerance 1.20 mm)	+/- 0.047 inch (+/-		
LZ		L1= L2 tolerance +/- 0.047 inch (+/- 1.20 mm)			

Part Marking System



Type 1- Side View



Type 2 - Top View

Packing Options

Part Number	Component Package	Quantity	Packaging Option
AK3-XXXX-Y	AK Package	56pcs/Box	Bulk
AK3-XXXX-Y-12	AK Package	12pcs/Box	Bulk

Part Numbering System



Please Refer to Electrical Characteristics Chart)

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